

0500
28E1

2811
Atty. Dkt. No. 039153-0457 (G1162)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Lopatin et al.

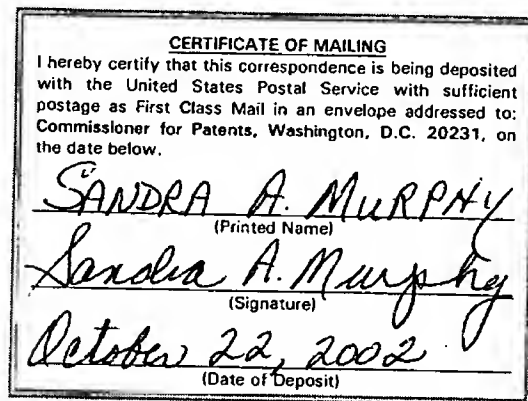
Title: METHOD OF USING TERNARY
COPPER ALLOY TO OBTAIN A
LOW RESISTANCE AND LARGE
GRAIN SIZE INTERCONNECT

Appl. No.: 09/994,395

Filing Date: 11/26/2001

Examiner: Unknown

Art Unit: Unknown



BEST AVAILABLE COPY

REQUEST TO RESCIND PREVIOUS NONPUBLICATION REQUEST

35 U.S.C. 122(b)(2)(B)(ii)

Commissioner for Patents
Washington, D.C. 20231

Sir:

Applicants hereby rescind the previous request that the above-identified application not be published under 35 U.S.C. 122(b).

Respectfully submitted,

Date OCT. 22, 2002

By

FOLEY & LARDNER
777 East Wisconsin Avenue
Milwaukee, Wisconsin 53202-5367
Telephone: (414) 297-5728
Facsimile: (414) 297-4900

Paul S. Hunter
Attorney for Applicant
Registration No. 44,787

RECEIVED
NOV -4 2002
TECHNOLOGY CENTER 2600